Design and Self-Assembly of
Open, Regular, 3D
Mesostructures

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Self-assembly provides the basis for a procedure used to organize millimeter-scale objects into regular, three-dimensional arrays ("crystals") with open structures. The individual components are designed and fabricated of polyurethane by molding; selected faces are coated with a thin film of liquid, metallic alloy. Under mild agitation in warm, aqueous potassium bromide solution, capillary forces between the films of alloy cause self-assembly. The structures of the resulting, self-assembled arrays are determined by structural features of the component parts: the three-dimensional shape of the components, the pattern of alloy on their surfaces, and the shape of the alloy-coated surfaces. Self-assembly of appropriately designed chiral pieces generates helices.

We describe a procedure that uses self-assembly of patterned, three-dimensional (3D), mesoscale (millimeter-to-centimeter-scale) objects to generate open, regular, 3D structures. These types of structures may eventually find use as the cores of densely interconnected, 3D electronic and optical elements for high-performance computation and sensors. We prepared millimeter-scale objects (both polyhedra and more complex shapes designed to form an extended lattice), coated selected faces with a film

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of low-melting, metallic alloy, and suspended the resulting particles in aqueous KBr solution at a temperature that melts the alloy. On agitation, the objects collide and interact through capillary forces between the drops of liquid alloy; self-assembly occurs because it minimizes the area of the interface between the alloy and the KBr solution and thus minimizes the free energy of the aggregate. The combination of the shapes of the objects, the pattern of the alloy-coated faces, and the shapes of the faces directs self-assembly and provides a strategy for controlling the structures of the resulting arrays.

This work builds on previous studies of 2D and 3D mesoscale self-assembly (1–8). In our studies of 2D systems, polymer plates floating at a perfluorodecalin/water interface interacted through lateral capillary forces; patterning the wettability of the surfaces of the plates directed the self-assembly (1). Achieving the same structural control in 3D self-assembly of small objects using capillarity is a more complicated problem—their previous work in 3D systems focused solely on simple tilings of space (4)—and requires a fluid-fluid interface with a high liquid-liquid interfacial free energy, a method to wet selected surfaces of the objects with only one of the liquids, and a procedure to freeze structures into mechanically stable forms once self-assembly is complete. We have addressed these issues by adapting a methodology originally used by Syme et al. to position the components of micromechanical assemblies (9). We used as liquid phases a low-melting alloy of bismuth, lead, tin, cadmium, and indium and aqueous KBr solution; the interface between these phases has a high interfacial free energy (we estimate this energy to be ~400 mN m⁻¹) (10) primarily as a result of the high surface tension of molten alloy. We formed mesoscale objects of polyurethane (PU) by molding, and patterned their surfaces with alloy, by first attaching pieces of an adhesive-backed copper foil to the surfaces (Fig. 1) (11). The patterned copper surface coated spontaneously with thin films of alloy when dipped in molten alloy at 60°C. Self-assembly of the objects was accomplished by suspending and agitating them in an aqueous KBr solution at 60°C. After self-assembly was complete, the suspension was allowed to cool to room temperature. The alloy solidified and the resulting structures were mechanically stable (12).

Design of component pieces that self-assemble into open arrays of specified design requires two structural features to be correctly chosen: (i) the 3D shape of the pieces, and (ii) the positions and shapes of the alloy-coated faces on the surfaces of the objects. Here, we demonstrate that design based on these features allows the fabrication by self-assembly of a range of shapes, including extended lattices, regular polyhedra, and open helices.

We chose regular polyhedra—octahedra, cubes, and tetrahedra—as the basis for the components for self-assembly of extended lattices and generated a new set of surface planes on them by truncating either their corners or edges. An important element of design in these systems was the shape of the alloy-coated surfaces of the mesoscopic objects (Fig. 2). Minimization of the area of the interface between the alloy and the aqueous KBr solution requires that the shapes of opposed faces between two objects match. Thus, the configurations suggested in Fig. 2, A and B, are energetically more favorable than those in Fig. 2, C and D, because they minimize the area of the alloy/aqueous KBr interface.

Both corner-truncated octahedra and edge-truncated cubes (Fig. 3) assembled into regular lattices: Truncated octahedra crystallized into a simple cubic lattice, and edge-truncated cubes formed a face-centered cubic lattice (Fig. 3, A to D); both used energetically favorable, area-minimizing configurations of the opposed faces (Fig. 2, A and B).

Both corner-truncated cubes and corner-truncated tetrahedra had triangular truncation planes covered with alloy (Fig. 3, E and G), and their shape, and the positions of the alloy-coated faces, prohibit the formation of an extended lattice with matching face profiles (such as in Fig. 2A). The corner-truncated tetrahedra assembled with matched configurations of the alloy-coated surfaces (Fig. 2A) and did not give an extended structure; rather, the pieces formed dodecahedra composed of five-membered rings of tetrahedra (Fig. 3F). In contrast, the corner-truncated cubes assembled into an extended lattice (Fig. 3H) but with unmatched configurations of the alloy-coated surfaces (Fig. 2C). These latter arrays are based on energetically less-favorable configurations of the opposed faces and, unlike the other arrays described in this study, had defects. These defects formed in the outer layer of components of the self-assembled structure when a component piece bonded to the structure with matched face profiles; only ~2% of the sites in the structure were defective.

Structures with matching face profiles were formed from the corner-truncated cubes when only four of the truncation planes, arranged tetrahedrally on the surface of each cube, were coated in alloy (Fig. 3, I and J). The cubes first formed five-membered rings with matching face profiles, and then dodecahedra analogous to those formed by the truncated tetrahedra. Five-membered rings formed only when four truncation planes were covered with alloy; when all eight corners were covered with alloy (Fig. 3, G and H), no dodecahedra formed. The additional alloy-covered truncation planes interfere with the formation of structures with matched face profiles, and complete opposition of the alloy-covered surfaces (to minimize the area of the interface of the alloy and aqueous solution) required formation of extended lattices, albeit at the cost of energetically unfavorable configurations of the opposed faces (Fig. 2C).

www.sciencemag.org  SCIENCE  VOL 284  7 MAY 1999  949
We extended the strategies illustrated by the regular crystalline lattices to a more complex structure, that is, a helix (Fig. 4). The components were designed to control both the direction of growth of the helix (so that it was along the length of the helix) and its handedness. The shapes used to form the helix incorporated three features. First, rectangles of alloy were placed on the sides of the components. Second, each piece subsumed an angle of 66° when projected along the axis of the helix; thus, assembly of six pieces resulted in 1.1 turns of the helix. Third, the components had S-shaped sides and were chiral. The aggregates that formed had helical structures and the correct handedness, but were limited to ~18 objects (~three turns of the helix). We believe the size of these structures was limited by shear forces encountered during agitation and assembly.

A strategy based on minimizing the interfacial free energy of the interface between metallic alloy and aqueous KBr allows the self-assembly of open structures, with complexity extending from regular lattice structures to helices. Successful design requires control of the shape of the objects, the placement of the surfaces supporting liquid alloy, and the shape of the helix. The number of alloy-coated faces per component is a factor that is independent of the shape of the faces; it controls the matching of the face profiles and thus the structure of the aggregate.

We have observed reproducible formation of defect-free lattices of at least 100 pieces (13); we have not explored or defined the upper limit of the number of components that assemble before defects begin to appear because of the time it takes to fabricate particles. These structures are free of defects commonly found in 2D self-assembled structures (14) and in 3D self-assembled arrays of cubes (4). We attribute the reduction in defect density to two facts. First, it is easier to form defect-free 3D structures than 2D structures because there are more interconnections and components in 3D structures to cause alignment of the components. Second, the high interfacial free energy of the alloy-aqueous KBr system results in bonds between components that are strong enough to prevent slip dislocations.

This system—polyhedra designed to self-assemble, molded in organic polymers, and connected through the use of capillary forces determined by minimization of the interfacial area between an alloy and aqueous KBr solution—is suitable for fundamental studies of self-assembly. The open lattice mosaics with metallic interconnects that it generates also represent a step toward new types of structural materials, optical band-gap materials, and other diffractive optical structures, and self-assembled, 3D microelectronic devices with built-in channels for cooling (15). The successful generation of these aggregates of millimeter-scale components suggests self-assembly as a strategy for precision assembly. To make the transition from fundamental studies to applications, we will require improved methods of fabrication of the components, methods of fabricating smaller components, and stronger adhesion between the components and the metallic alloy patterned on their surfaces.

References and Notes
10. We estimated the interfacial free energy of the alloy/aqueous KBr interface using data from F. H. Howie and E. D. Hondros, J. Mater. Science 17, 1434 (1982); M. A. Carroll and M. E. Warren, Mater. Sci. Technol. 3, 1040 (1987); and Handbook of Chemistry and Physics, D. R. Lide, Ed. (CRC Press, Boston, ed. 71, 1990), pp. 4-137 to 4-143. A liquid with a lower surface tension, such as the hydrophobic lubricant used in (2) and (4), was unable to generate capillary forces that were strong enough to hold objects together.
11. The designs selected for the components were used to fabricate machined aluminum masters; these masters were used to fabricate an elastomeric mold. We placed the masters in a petri dish, covered them with a liquid polydimethylsiloxane prepolymer (Sylgard 184, DuPont), and cured the prepolymer with heat (60°C, 30 min). Subsequent removal of the aluminum masters left an elastomeric mold consisting of wells in the shape of the aluminum masters. We filled the wells with a liquid PU prepolymer (NOA 73, Norland), cured the polymer by exposure to ultraviolet light (45 min), and removed the solid PU pieces. We patterned selected faces of these objects using adhesive copper foil (Scotch Brand Electrical Tape, 3M Corp., St. Paul, MN). This tape was cut to size and applied to the selected planes (or portions of these planes) of the polyhedra. This process was labor-intensive and limited the number of objects we were willing to examine in any experiment; it also limited these objects to sizes greater than 5 mm. The pattern of copper foil was coated with molten alloy (Bismuth Alloy 117, melting point: 47°C, Small Parts, Miami Lakes, FL) by dipping the pieces into a beaker containing molten alloy (under an aqueous acetic acid solution at pH 4 to dissolve oxidized alloy). Cooling left the faces of the copper foil coated with a film (~0.5 mm thick) of solid alloy. Self-assembly was allowed to take place in a 500-ml Morton flask filled with an aqueous solution of KBr. Acetic acid (3 ml) was added to dissolve oxide from the surface of the alloy. The flask and its contents were rotated horizontally with a rotary evaporator motor at 5 to 10 rpm and heated to 60°C in an oil bath. A typical assembly was complete after ~1 hour of agitation. We reduced the intensity of agitation about halfway through the experiment to obtain complete assemblies of the component pieces by increasing the concentration and thus the density (ranging from 1.1 to 1.3 g/ml) of the aqueous KBr solution.
12. Fragility resulted from delamination of tape from polymer, not fracture of alloy connections.
13. We assembled each array twice (with the exception of the dodecahedra, which were assembled three times). With the exception of the dodecahedra, the arrays incorporated all the starting pieces; for the dodecahedra, an excess of pieces was required. If we broke apart an array during assembly with a brief increase in rotation speed, the resulting fragments reassembled into a crystalline, monolithic array in ~1 hour.
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www.sciencemag.org SCIENCE VOL 284 7 MAY 1999 951